CRMYTL10120A

N-Channel 100V, 96mΩ Typ. Power MOSFET

Description

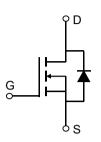
Features

• 100V, 6A

$$R_{DS(ON)}$$
 Typ = 96m Ω @ V_{GS} = 10V

$$R_{DS(ON)}$$
 Typ = $101m\Omega$ @ V_{GS} = $4.5V$

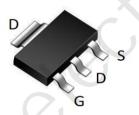
- Advanced Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- Lead Free

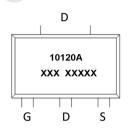




Application

- Load Switch
- PWM Application
- Power Management





Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMYTL10120A	10120A	SOT-223-3L	TAPING	13"	4000	48000

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

	0 (0)	<u> </u>	<u>, </u>	
Symbol	Parameter		Value	Units
V_{DS}	Drain-to-Source Voltage		100	V
V_{GS}	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	T _A = 25°C	6	Α
I _D	Continuous Drain Current	T _A = 100°C	3.6	А
I _{DM}	Pulsed Drain Current (1)		24	А
P_{D}	Power Dissipation	T _A = 25°C	7.8	W
$R_{\scriptscriptstyle{\theta JA}}$	Thermal Resistance, Junction to Amb	pient ⁽²⁾	16	°C/W
T_J,T_STG	Junction & Storage Temperature Ran	nge	-55 to 150	°C

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Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Uni
Off Chara	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	100	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 100V, V _{GS} = 0V	-	-	1.0	μΑ
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				6	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1	1.5	2.2	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽³⁾	$V_{GS} = 10V, I_D = 3A$	-	96	125	mΩ
		$V_{GS} = 4.5V, I_D = 2A$	-	101	131	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		-(811	-	pF
C_{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = 25V,$ f = 1MHz	X-\	50	-	pF
C_{rss}	Reverse Transfer Capacitance	1 – 1101112		35	-	pF
Q_g	Total Gate Charge		<u></u> -	20	-	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 50V, I_{D} = 2A$	-	2.8	-	nC
Q_{gd}	Gate Drain("Miller") Charge	V _{DS} - 30V, I _D - 2A	-	4	-	nC
Switchin	g Characteristics					
t _{d(on)}	Turn-On DelayTime		-	6	-	ns
t _r	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 50V$	-	7	-	ns
$t_{\text{d(off)}}$	Turn-Off DelayTime	I_{D} = 3A, R_{GEN} = 1.8 Ω	-	21	-	ns
t_{f}	Turn-Off Fall Time		-	3	-	ns
Drain-So	urce Diode Characteristics and N	Max Ratings				
Is	Maximum Continuous Drain to Source Di	ode Forward Current	-	-	6	А
I _{SM}	Maximum Pulsed Drain to Source Diode	Forward Current	-	-	24	А
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S = 3A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	1 0A 17/11 100A7	-	22	-	ns
Qrr	Body Diode Reverse Recovery Charge	$I_F = 3A$, di/dt = 100A/us	_	29	_	nC

Notes:

^{1.} Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

^{2.} $R_{\theta JA}$ is measured with the device mounted on a 1inch² pad of 2oz copper FR4 PCB

^{3.} Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.



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Test Circuit

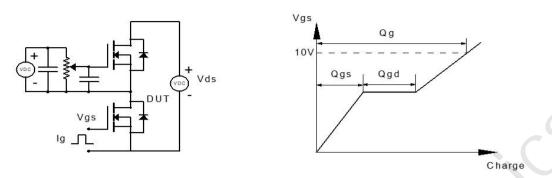


Figure 1: Gate Charge Test Circuit & Waveform

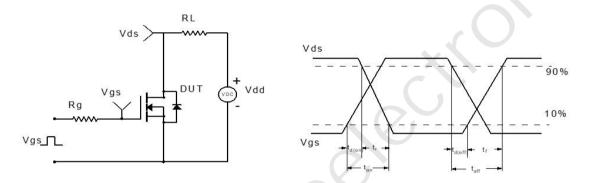


Figure 2: Resistive Switching Test Circuit & Waveform

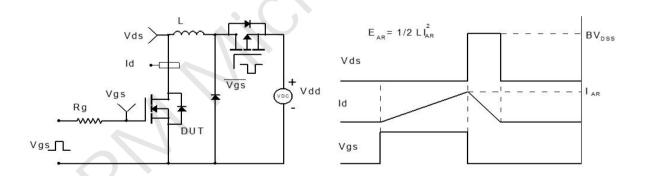


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

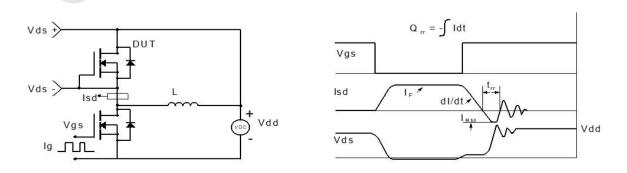
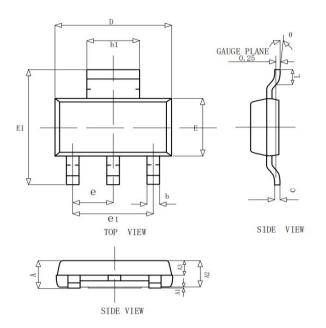


Figure 4: Diode Recovery Test Circuit & Waveform

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Package Mechanical Data(SOT-223-3L)



COMMON DIMENSIONS
(UNITS OF MEASURE=mm)

SYMBOL	MIN	NOM	MAX	
Α			1.80	
A1	0.00	0.05	0.10	
A2	1.50	1.60	1.70	
A3	0.85	0.90	0.95	
b	0.66	0.70	0.80	
b1	2.96	3.00	3.10	
С	0.25	0.30	0.35	
D	6.30	6.50	6.70	
E	3.30	3.50	3.70	
E1	6.80	7.00	7.20	
е	2.3BSC			
e1	4.40	4.60	4.80	
L	0.90	-	1.15	
θ	0°	5°	10°	

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